

Development of a medium-sized photon counting UFXC-demonstrator at SOLEIL synchrotron

Marie Andrä¹, El-Houssain Ait-Mansour¹, Jérôme Bisou¹, Arkadiusz Dawiec¹, Pawel Grybos², Brahim Kanoute¹, Claude Menneglier¹, Fabienne Orsini¹

1. SOLEIL Synchrotron, Saint-Aubin, 91192 Gif-sur-Yvette, France

2. Department of Measurement and Electronics, AGH University of Science and Technology, Krakow 30-059, Poland

marie.andrae@synchrotron-soleil.fr

ULTRA FAST X-RAY CAMERA DEMONSTRATOR with 8 CHIPS

A hybrid photon-counting pixel detector of medium size with very high frame rate, high count rate capability and short gating time for time-resolved

pump-probe experiments and other new or existing applications

UFXC32k readout chip designed at AGH-UST, Krakow

- 128 x 256 pixels with 75 µm pitch
- Two discriminators with 7 trimbits each and two 14-bit counters per pixel

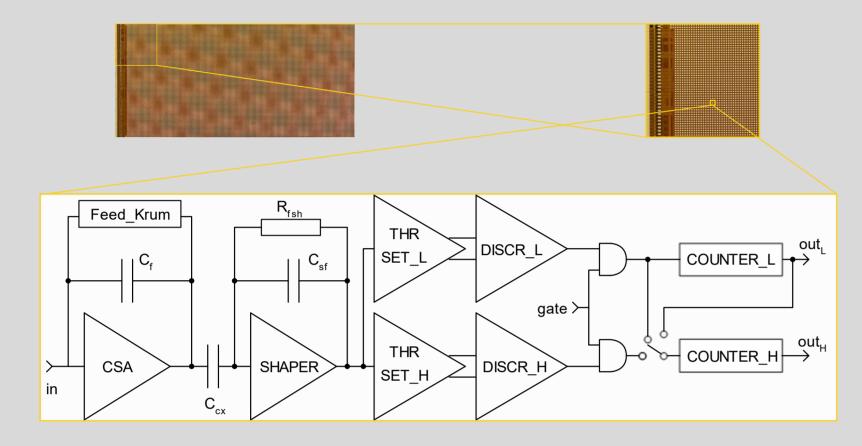
U8DEM module

- Evolution of the existing 2-chip system tested at SOLEIL
- Single Si-sensor (320 µm or 450 µm thickness), bump bonded to

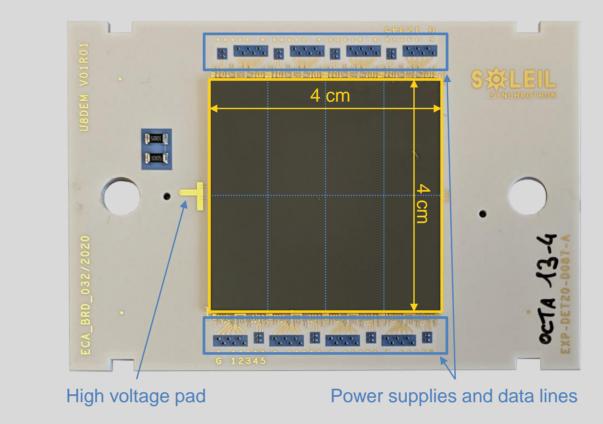
Detector

- Compact (16 x 28 x 11 cm³) and light (~3 kg) mechanics
- Efficient water cooling (up to 50 W)

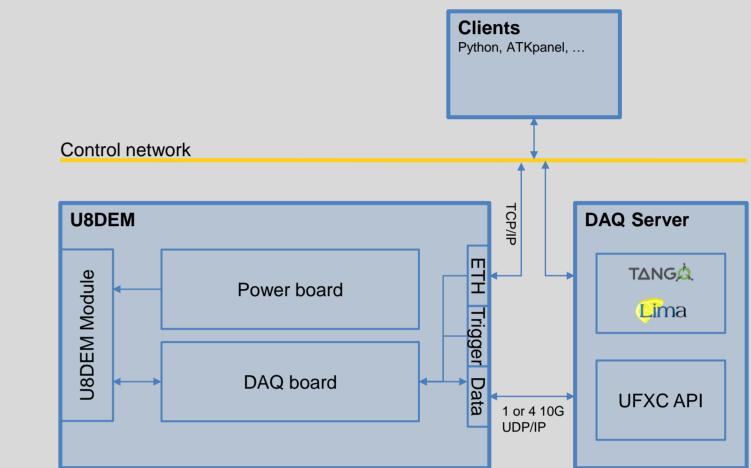
- Adjustable gain and frontend speed
- Selectable readout counter depth (2, 4, 8, 14 or 28-bit)
- Minimum exposure time < 100 ns
- High count rate linearity > 10⁶ ph/pix/s (at 90 % counting efficiency)



- eight UFXC32k readout chips
- Detection area: 4 × 4 cm² (250k pixels with 75 µm pitch, including single pixel inter-chip spacing)
- Ceramic PCB (LTCC, 88 × 60 mm²)
- Single high density connector on the backside



- Power board
- Acquisition board with FPGA
- I or 4 x 10G QSFP connections for data transfer
- Power consumption of the detector head < 25 W</p>



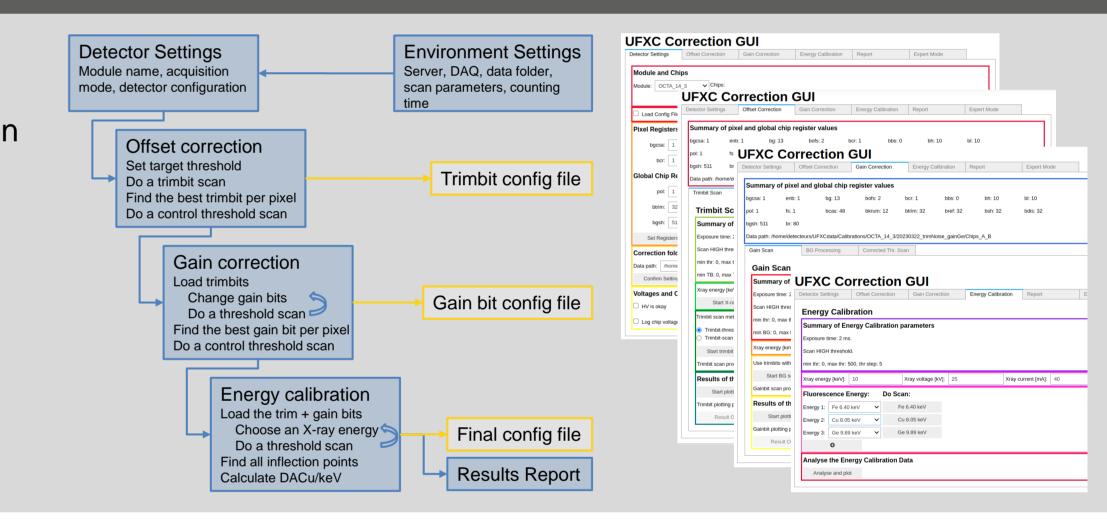
FIRMWARE AND SOFWARE STATUS

Firmware + Library developed for U8DEM

- Based on firmware + decoding library made for the 2-chip system
- Interface to TANGO and LIMA to ease integration into the SOLEIL beamline control system
- Controls 8 chips simultaneously
- Frame rate between 3.4 kHz and 23 kHz (depending on the acquisition mode)
- Based on FEM-II acquisition board (Virtex 6 FGPA + Zynq SoC)

Correction + Calibration Software

- Semi-automatised offset and gain correction and energy calibration
- Control of the detector and X-ray generator (via TANGO devices)
- Generates the configuration files and pixel mask
- Displays and saves all resulting plots and data
- GUI based on Jupyter-Notebook widgets
- Under finalization

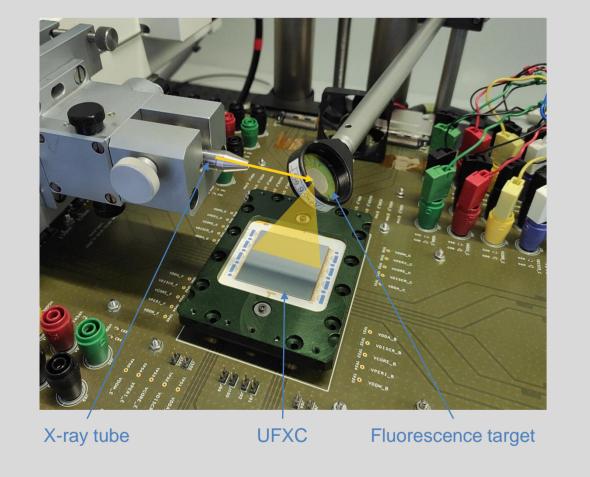


Under finalization

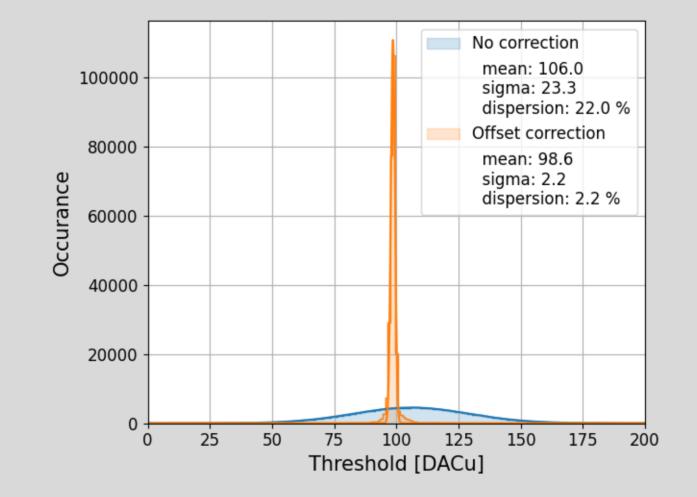
FIRST CHARACTERISATION MEASUREMENTS

All presented measurements have been acquired with the existing 2-chip readout system and in the laboratory X-ray setup using fluorescence photons. The data of all 8 chips are presented.

Laboratory X-ray setup

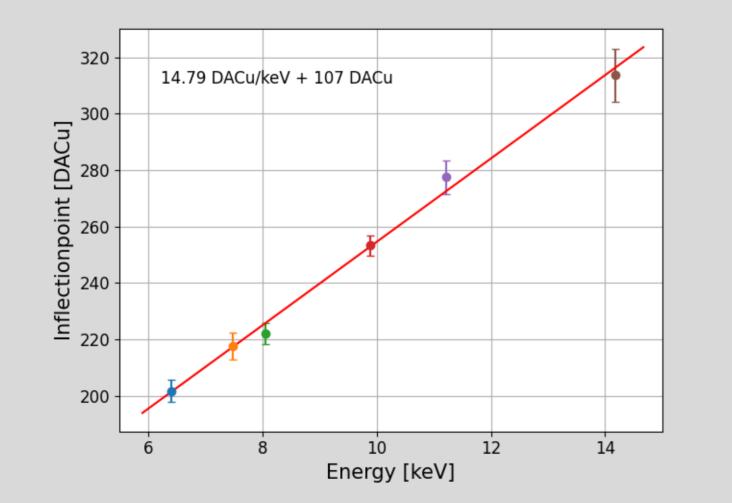


Offset spread



Very low offset spread after the correction

Energy Calibration



Threshold dispersion @ 10 keV

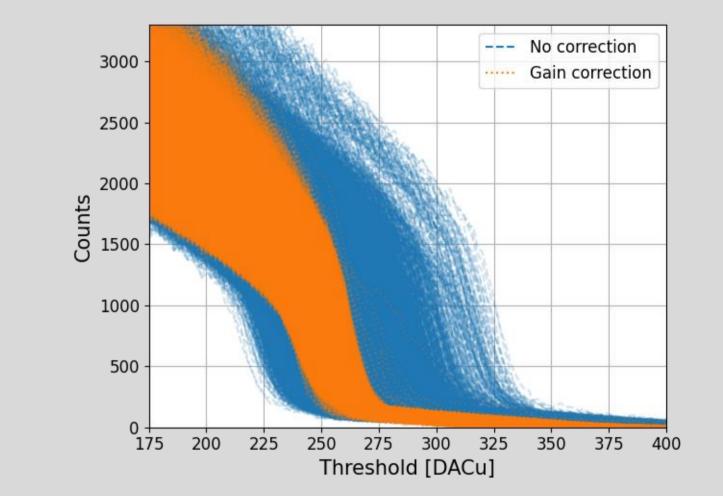
30000 No correction mean: 252.1 sigma: 7.5 25000 dispersion: 3.0 % Gain correction mean: 250.0 <u>9</u> 20000 5 sigma: 3.1 dispersion: 1.2 % CC 15000 ŏ 10000 5000 220 240 260 280 300 200 Threshold [DACu]

Reduced threshold dispersion < 2% after gain correction

Imaging setup at the beamline



Corrected threshold scans @ 10 keV



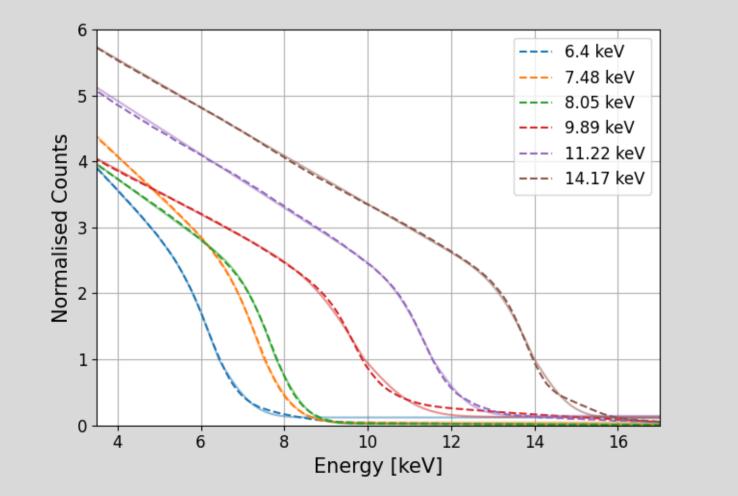
Threshold scans before and after gain correction

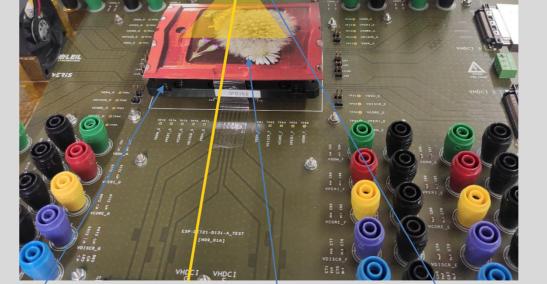
First imaging @ 10 keV



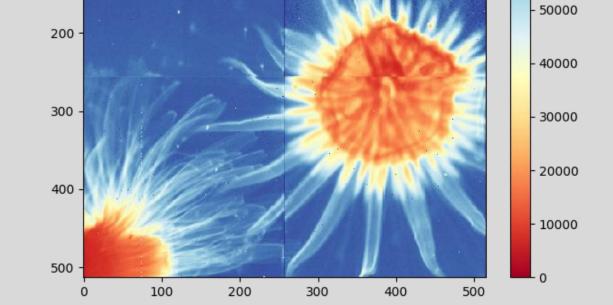
Fluorescence setup with temporary readout system

Threshold scans at different energies





UFXC X-ray beam Imaging sample Fluorescence target



Median threshold scans after corrections at low gain

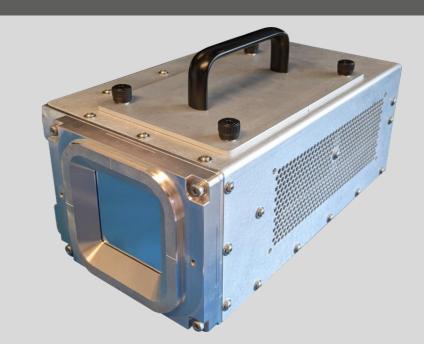
Median energy calibration at low gain

UFCX with imaging sample using fluorescence photons

Flatfield and inter-chip gap correction Shifts in the image are due to the composition of four 2-chip images taken one after the other

SUMMARY AND OUTLOOK

- An 8-chip demonstrator has been developed
- ✓ Offset, gain correction and energy calibration work as expected
- ✓ Validated good quality of several hybrid modules
- Firmware and software are in the final development stage
- Goal: Have the first fully assembled and operational U8DEM detector by end 2023 / beginning 2024



REFERENCES

[1] A. Dawiec et al., AIP Conf. Proc. 2054, 060067, (2019) [2] P. Grybos et al., IEEE Trans. Nucl. Sci. 63 1155, (2016) [3] D. Bachiller-Perea et al., J. Synchrotron Rad. 27, (2020)

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